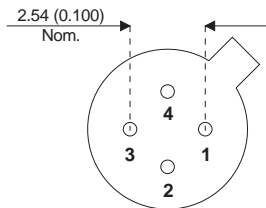
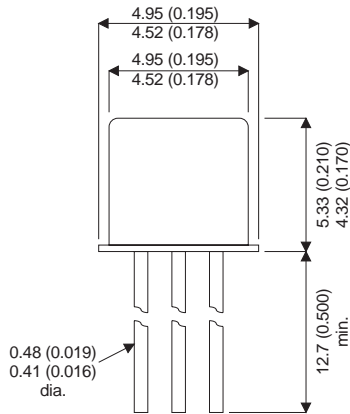


**MECHANICAL DATA**

Dimensions in mm (inches)



**TO72**

**SILICON PLANAR EPITAXIAL  
NPN TRANSISTOR**

**DESCRIPTION**

The BFY90 is a low noise transistor intended for use in broad and narrow-band amplifiers up to 1GHz.

- Pin 1 – Emitter
- Pin 2 – Base
- Pin 3 – Collector
- Pin 4 – Connected to Case

**ABSOLUTE MAXIMUM RATINGS** ( $T_A = 25^\circ\text{C}$  unless otherwise stated)

$V_{CBO}$	Collector – Base Voltage	30V
$V_{CER}$	Collector – Emitter Voltage ( $R_{BE} \leq 50\Omega$ )	30V
$V_{CEO}$	Collector – Emitter Voltage	15V
$V_{EBO}$	Emitter – Base Voltage	2.5v
$I_{C(AV)}$	Average Collector Current	25mA
$I_{CM}$	Peak Collector Current ( $f \geq 1\text{MHz}$ )	50mA
$P_{tot}$	Power Dissipation at $T_{amb} = 25^\circ\text{C}$	200mW $^\circ\text{C}$
$T_j$	Storage Temperature	200 $^\circ\text{C}$
$T_{stg}$	Junction Temperature	-65 to +200 $^\circ\text{C}$

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise stated)

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$I_{CBO}$	Collector Cut Off Current $V_{CB} = 15\text{V}$ $I_E = 0$			10	nA
$V_{(BR)CEO}^*$	Collector Emitter Breakdown Voltage $I_C = 10\text{mA}$ $I_B = 0$	15			V
$V_{(BR)CER}^*$	Collector Emitter Breakdown Voltage $I_C = 10\text{mA}$ $R_{BE} \leq 50\Omega$	30			
$V_{CEK}$	Collector Emitter Knee Voltage $I_C = 10\text{mA}$			0.75	
$h_{21E}$	Static Forward Current Transfer Ratio $V_{CE} = 1\text{V}$ $I_C = 2\text{mA}$	25		150	—
	$V_{CE} = 1\text{V}$ $I_C = 25\text{mA}$	20		125	
<b>DYNAMIC CHARACTERISTICS</b>					
$f_T$	Transition Frequency $V_{CE} = 5\text{V}$ $I_C = 2\text{mA}$ $f = 500\text{MHz}$	1			GHz
				1.3	
$C_{22b(1)}$	Output Capacitance $V_{CB} = 10\text{V}$ $I_E = 0$ $f = 1\text{MHz}$			1.5	pF
$C_{12e(2)}$	Open-Circuit Reverse Transfer Capacitance $V_{CE} = 5\text{V}$ $I_C = 0$ $f = 1\text{MHz}$			0.8	pF
NF	Noise Figure $V_{CE} = 5\text{V}$ $I_C = 2\text{mA}$ $f = 100\text{kHz}$ $R_G$ optimum			4	dB
				3.5	
				5	
			5		
$G_p$	Power Gain $V_{CE} = 10\text{V}$ $I_C = 14\text{mA}$ $f = 200\text{MHz}$	21			dB
$P_{O(2)}$	Output Power $V_{CE} = 10\text{V}$ $I_C = 14\text{mA}$ $f_1 = 202\text{MHz}$ $f_2 = 205\text{MHz}$ Output SWR $\leq 2$ TOS sortie $\leq 2$ $d_{IM}^* = -30\text{dB}$ at $2f_2 - f_1 = 208\text{MHz}$	10			mW

**THERMAL DATA**

$R_{th(j-a)}$	Junction-ambient thermal resistance	$\leq 0.875$ Max	$^\circ\text{C/W}$
$R_{th(j-c)}$	Junction-case thermal resistance	$\leq 0.575$ Max	$^\circ\text{C/W}$

\* Pulse test  $t_p = 300\mu\text{s}$ ,  $\delta \leq 2\%$

(1) Shield Lead (case) not connected

(2) Shield Lead (case) grounded

\* Intermodulation Distortion

This datasheet has been download from:

[www.datasheetcatalog.com](http://www.datasheetcatalog.com)

Datasheets for electronics components.